

# XN04609 (XN4609)

Silicon NPN epitaxial planar type (Tr1)  
 Silicon PNP epitaxial planar type (Tr2)

For amplification of low-frequency output (Tr1)

For general amplification (Tr2)

## ■ Features

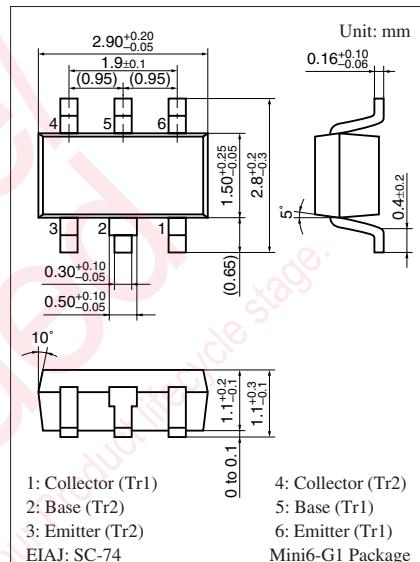
- Two elements incorporated into one package
- Reduction of the mounting area and assembly cost by one half

## ■ Basic Part Number

- 2SD1328 + 2SB0709A (2SB709A)

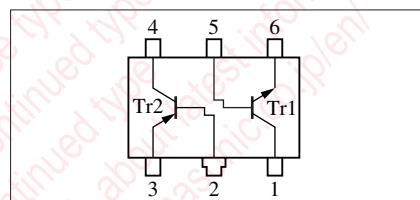
## ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

	Parameter	Symbol	Rating	Unit
Tr1	Collector-base voltage (Emitter open)	$V_{CBO}$	25	V
	Collector-emitter voltage (Base open)	$V_{CEO}$	20	V
	Emitter-base voltage (Collector open)	$V_{EBO}$	12	V
	Collector current	$I_C$	0.5	A
	Peak collector current	$I_{CP}$	1	A
Tr2	Collector-base voltage (Emitter open)	$V_{CBO}$	-60	V
	Collector-emitter voltage (Base open)	$V_{CEO}$	-50	V
	Emitter-base voltage (Collector open)	$V_{EBO}$	-7	V
	Collector current	$I_C$	-100	mA
	Peak collector current	$I_{CP}$	-200	mA
Overall	Total power dissipation	$P_T$	300	mW
	Junction temperature	$T_j$	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: 5F

## Internal Connection



Note) The part number in the parenthesis shows conventional part number.

**■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C**

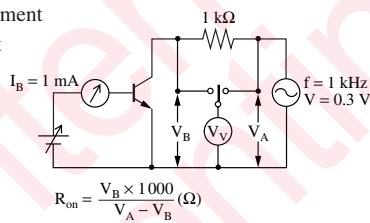
## • Tr1

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0	25			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	I <sub>C</sub> = 1 mA, I <sub>B</sub> = 0	20			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	I <sub>E</sub> = 10 μA, I <sub>C</sub> = 0	12			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	V <sub>CB</sub> = 25 V, I <sub>E</sub> = 0			0.1	μA
Forward current transfer ratio * <sup>1</sup>	h <sub>FE1</sub>	V <sub>CE</sub> = 2 V, I <sub>C</sub> = 0.5 A	200	800		—
	h <sub>FE2</sub>	V <sub>CE</sub> = 2 V, I <sub>C</sub> = 1 A	60			
Collector-emitter saturation voltage * <sup>1</sup>	V <sub>CE(sat)</sub>	I <sub>C</sub> = 0.5 A, I <sub>B</sub> = 20 mA		0.13	0.40	V
Base-emitter saturation voltage * <sup>1</sup>	V <sub>BE(sat)</sub>	I <sub>C</sub> = 0.5 A, I <sub>B</sub> = 20 mA			1.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = -50 mA, f = 200 MHz	200			MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MHz		10		pF
ON resistance * <sup>2</sup>	R <sub>on</sub>			1.0		Ω

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

\*2: R<sub>on</sub> test circuit

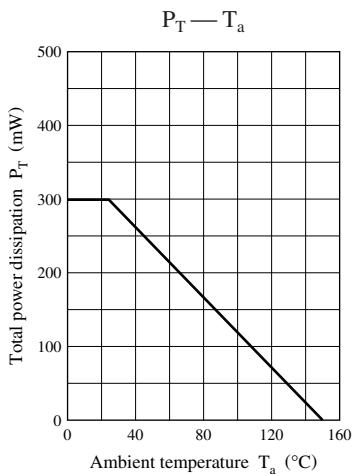


## • Tr2

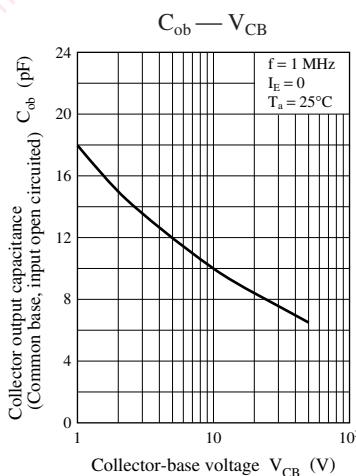
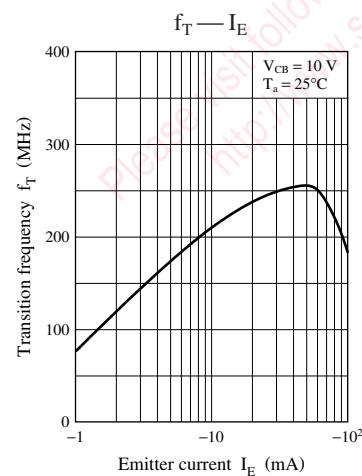
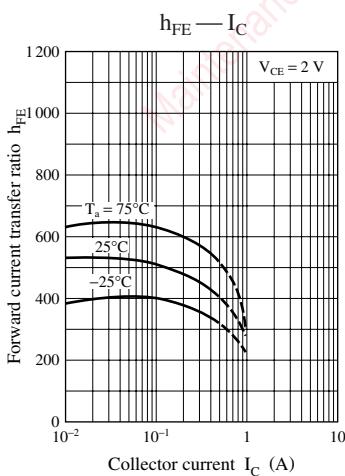
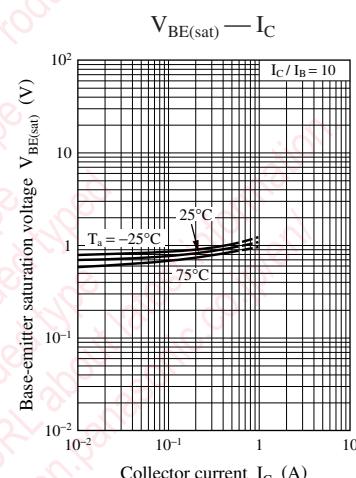
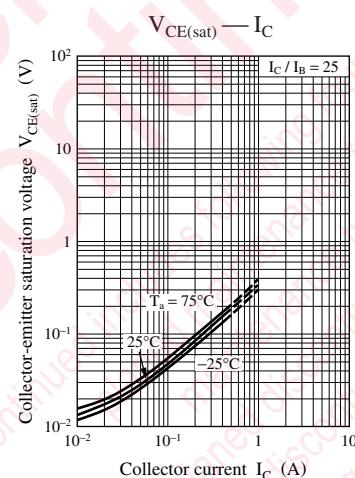
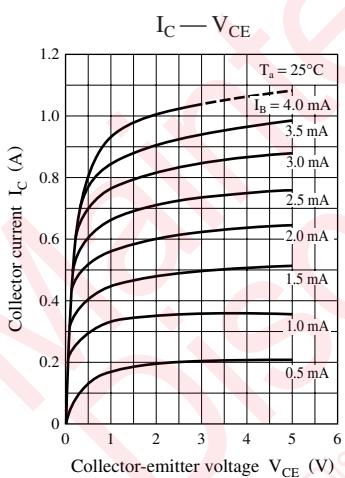
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	I <sub>C</sub> = -10 μA, I <sub>E</sub> = 0	-60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	I <sub>C</sub> = -2 mA, I <sub>B</sub> = 0	-50			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	I <sub>E</sub> = -10 μA, I <sub>C</sub> = 0	-7			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	V <sub>CB</sub> = -20 V, I <sub>E</sub> = 0			-0.1	μA
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	V <sub>CE</sub> = -10 V, I <sub>B</sub> = 0			-100	μA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = -10 V, I <sub>C</sub> = -2 mA	160	460		—
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -100 mA, I <sub>B</sub> = -10 mA		-0.3		V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 1 mA, f = 200 MHz	80			MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 1 MHz		2.7		pF

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

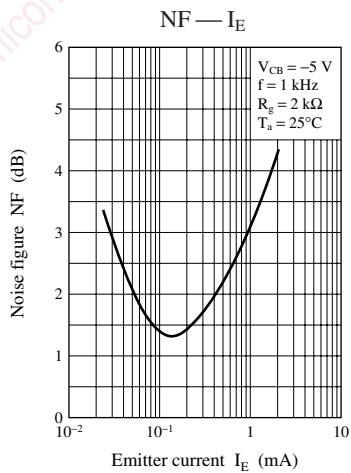
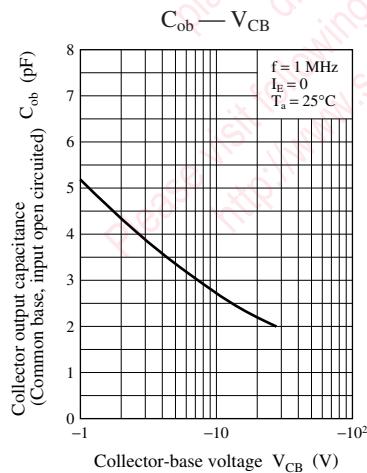
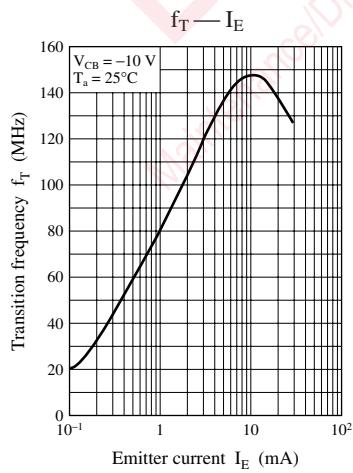
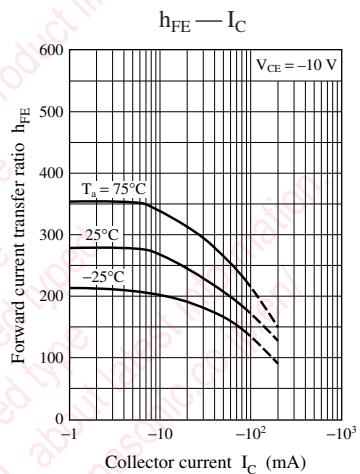
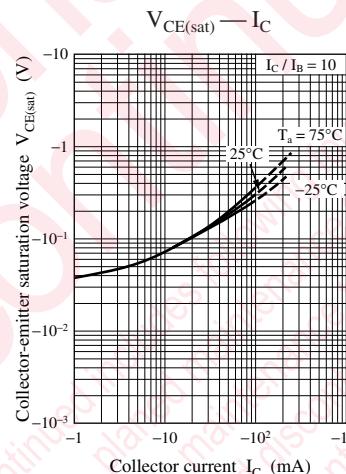
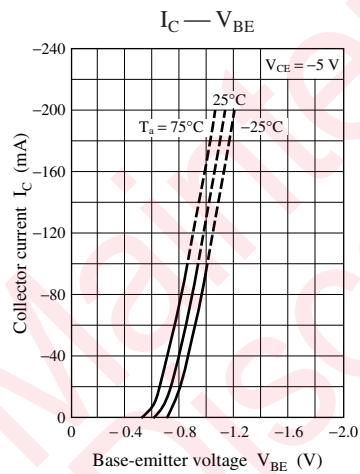
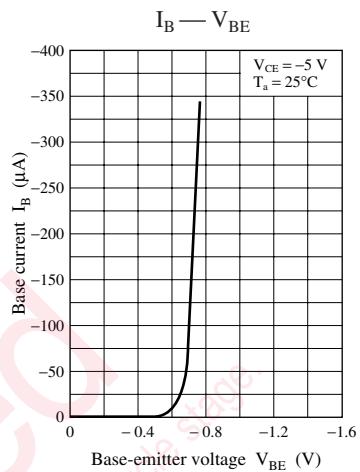
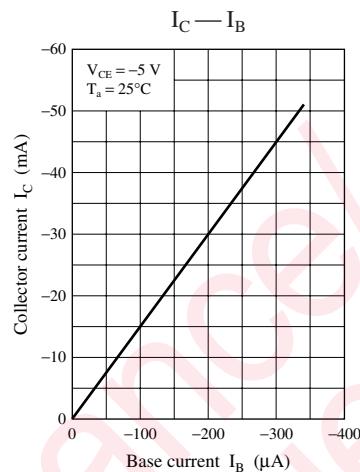
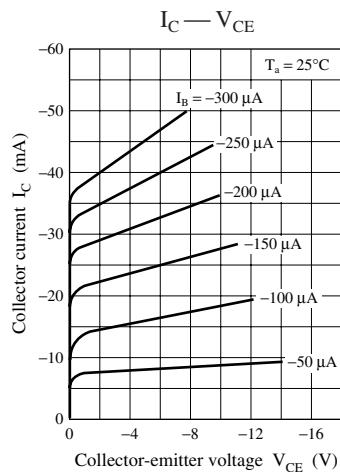
## Common characteristics chart

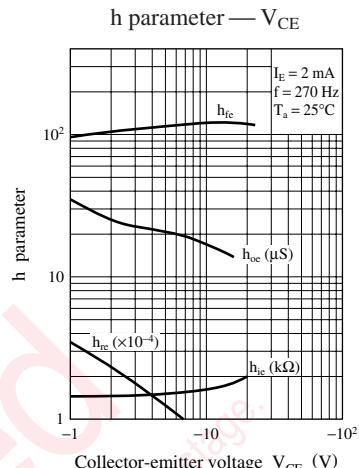
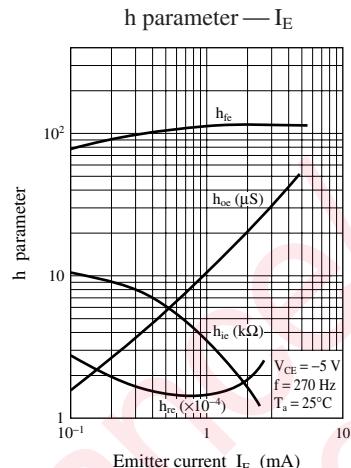
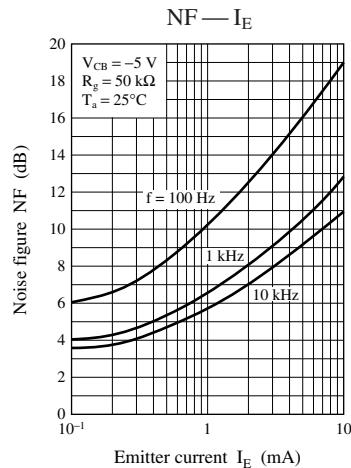


## Characteristics charts of Tr1



## Characteristics charts of Tr2





Maintained  
Discontinued

Maintenance/Discontinued includes following four Product lifecycle type

planed maintenance type

planed discontinued type

discontinued type

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